BORN SEMICONDUCTOR

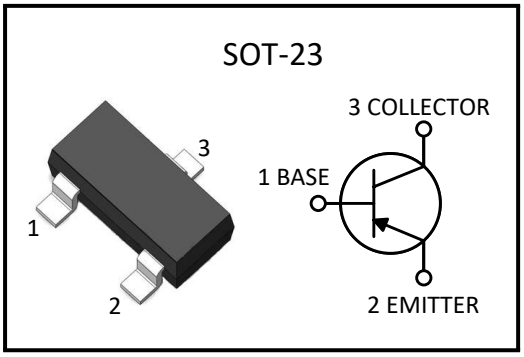
MMBT5401

PNP Plastic-Encapsulate Transistor

Features

- V_{CE}=-150V
- I_C=-0.6A
- f_T=100MHZ @V_{CE}=-5V, I_C=-10mA,f=30MHz

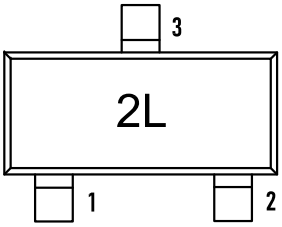
Package



Description

- Complementary to MMBT5551
- Epitaxial planar die constructio
- SOT-23 Plastic Package.

Marking



Ordering information

Order code	Package	Marking	Base qty	Delivery mode
MMBT5401	SOT-23	2L	3K	Tape and reel

Absolute Maximum Ratings @T_A=25°C unless otherwise noted

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	-160	V
V_{CEO}	Collector-Emitter Voltage	-150	V
V_{EBO}	Emitter-Base Voltage	-5	V
I_C	Collector Current	-0.6	A
P_C	Collector Power Dissipation	300	mW
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	416	°C/W
T_J	Junction Temperature	150	°C
T_{stg}	Storage Temperature	-55 to + 150	°C

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MMBT5401

PNP Plastic-Encapsulate Transistor

Electrical Characteristics (T_A=+25°C, unless otherwise specified)

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
$V_{(BR)CBO}$	Collector-base breakdown voltage	I_C=-100μA, I_E=0	-160	–	–	V
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	I_C=-1mA,I_B=0	-150	–	–	
$V_{(BR)EBO}$	Emitter-base breakdown voltage	I_E=-10μA,I_C=0	-5	–	–	
I_{CBO}	Collector cut-off current	V_{CB}=-120V,I_E=0	–	–	-0.1	uA
I_{EBO}	Emitter cut-off current	V_{EB}=-4V,I_C=0	–	–	-0.1	
$h_{FE(1)}$	DC current gain	V_{CE}=-5V,I_C=-1mA	80	–	–	
$h_{FE(2)}$		V_{CE}=-5V,I_C=-10mA	100	–	300	
$h_{FE(3)}$		V_{CE}=-5V,I_C=-50mA	30	–	–	
$V_{CE(sat)}$	Collector-emitter saturation voltage	I_C=-10mA,I_B=-1mA	–	–	-0.2	V
		I_C=-50mA,I_B=-5mA	–	–	-0.5	
$V_{BE(sat)}$	Base-emitter saturation voltage	I_C=-10mA,I_B=-1mA	–	–	-1.00	
		I_C=-50mA,I_B=-5mA	–	–	-1.00	
f_T	Transition frequency	V_{CE}=-5V,I_C=10mA,f=30MHZ	100	–	–	MHZ
$h_{FE(2)}$Rank	L(100-200)	H(200-300)				

Note:Pulse test: pulse width≤300us, duty cycle≤2.0%

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PNP Plastic-Encapsulate Transistor

Typical Performance Characteristics(T_J = 25 °C, unless otherwise noted)

Figure 1 : I_C—— V_{CE}

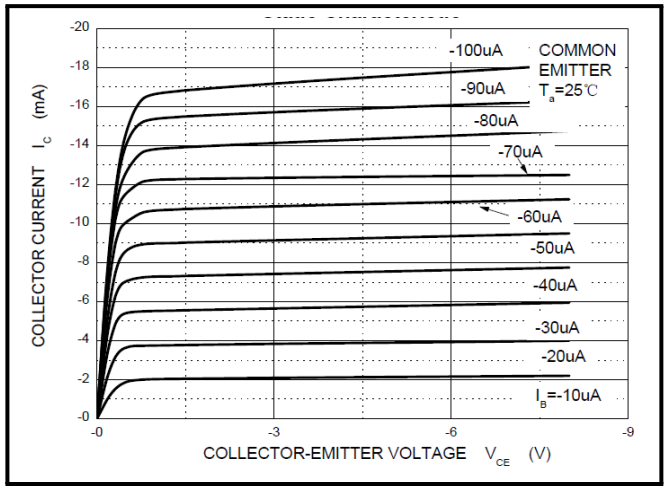


Figure 2 :h_{FE}——I_C

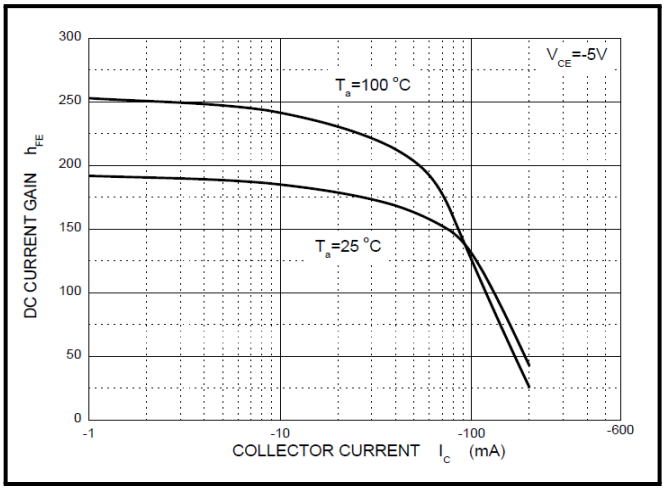


Figure 3 : $V_{BE(sat)}$—— I_C

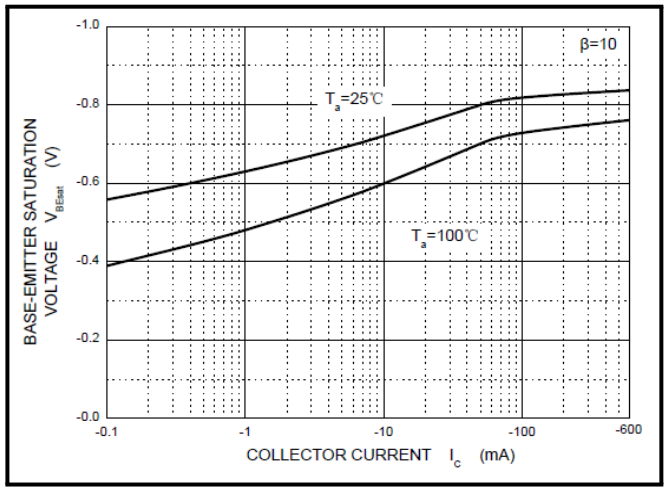


Figure 4 : $V_{CE(sat)}$——I_C

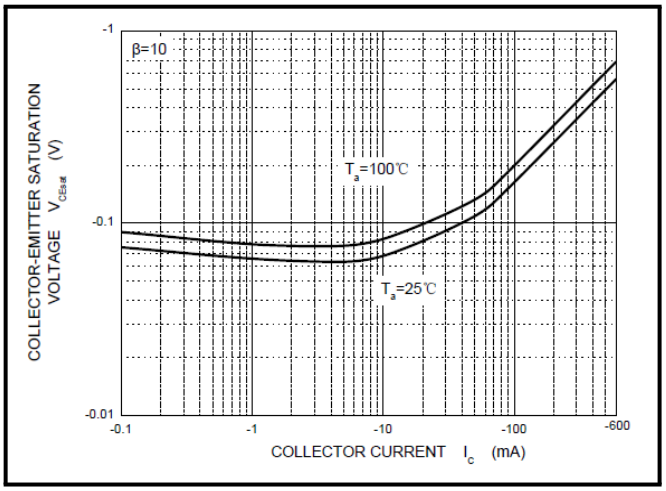


Figure 5 : I_C——V_{BE}

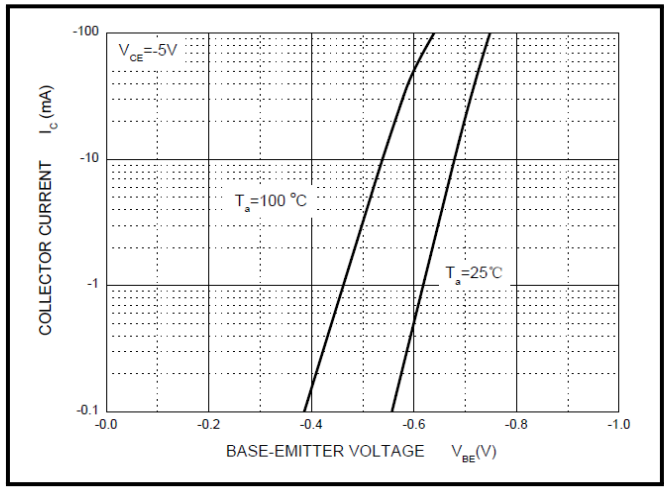
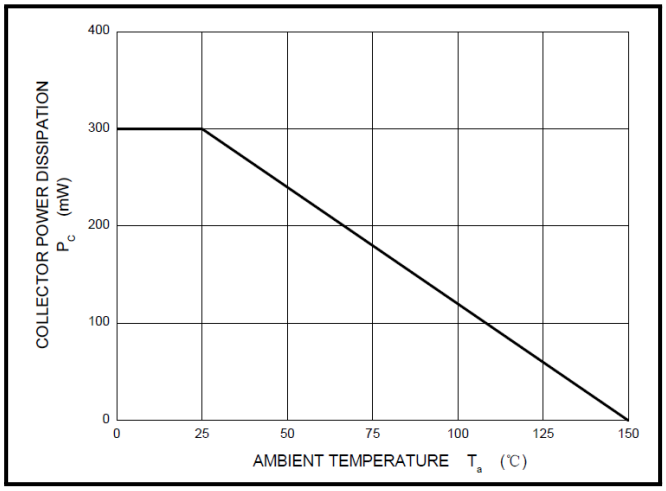


Figure 6 : P_C——T_a



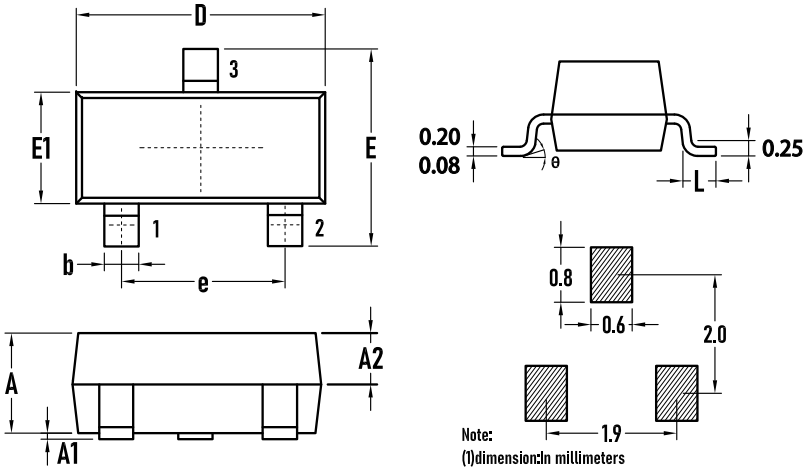
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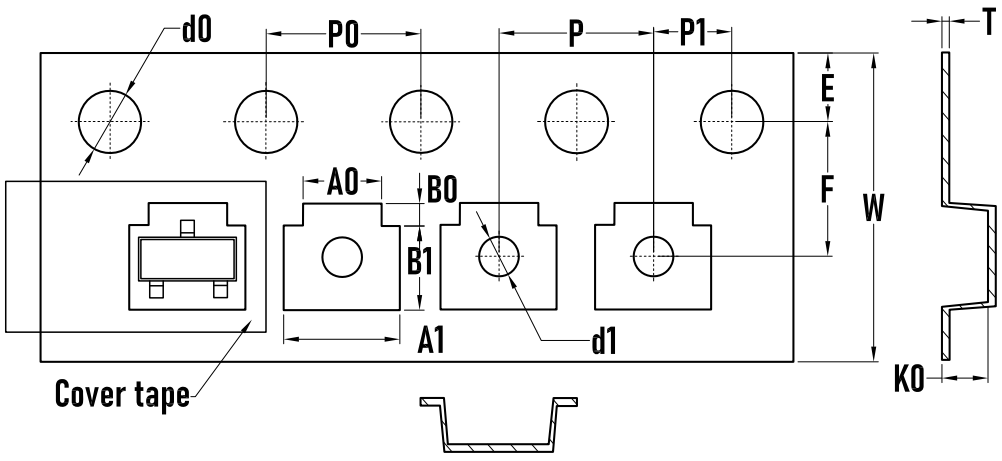
PNP Plastic-Encapsulate Transistor

Outline Drawing - SOT-23



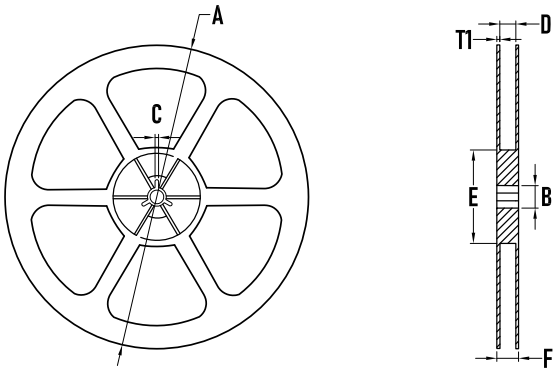
SYMBOL	MILLIMETER		
	MIN.	Typ	MAX
A	0.90	1.00	1.10
A1	0.01	–	0.10
A2	0.50	0.60	0.70
D	2.80	2.90	3.00
b	0.25	0.35	0.45
E	2.10	2.30	2.50
E1	1.20	1.30	1.40
e	1.80	1.90	2.00
L	0.25	0.35	0.45
θ	0	–	8°

Packaging Tape - SOT-23



SYMBOL	MILLIMETER
A0	2.10±0.10
A1	3.10±0.10
B0	0.65±0.10
B1	2.75±0.10
d0	1.55±0.10
d1	1.00±0.05
E	1.75±0.10
F	3.50±0.10
K0	1.10±0.10
P	4.00±0.10
P0	4.00±0.10
P1	2.00±0.10
W	8.00±0.30
T	0.20 ±0.05

Packaging Reel



SYMBOL	MILLIMETER
A	177.8±0.2
B	3.1
C	13.50
D	9.6±0.3
E	75±0.2
F	12.3±0.3
T1	1.0±0.2
Quantity	3000PCS

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